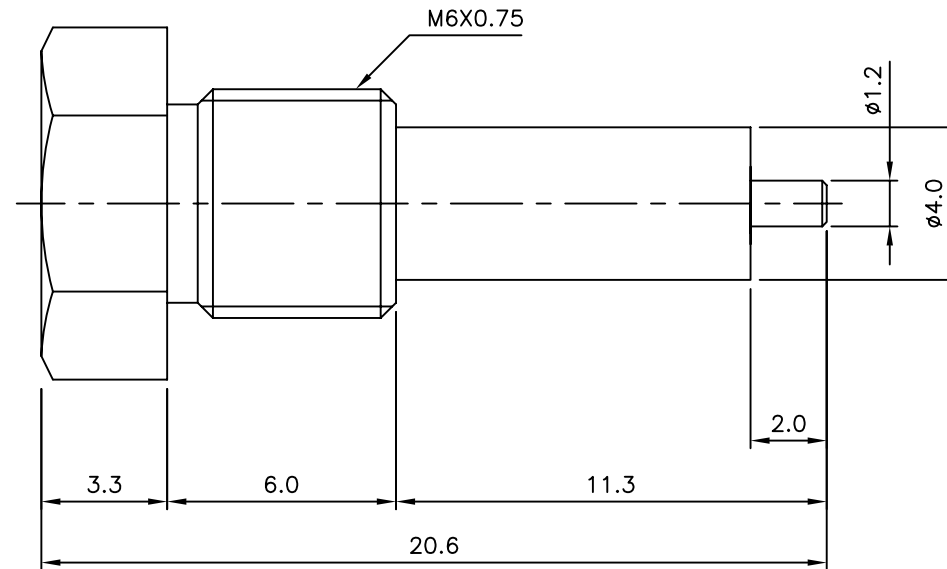
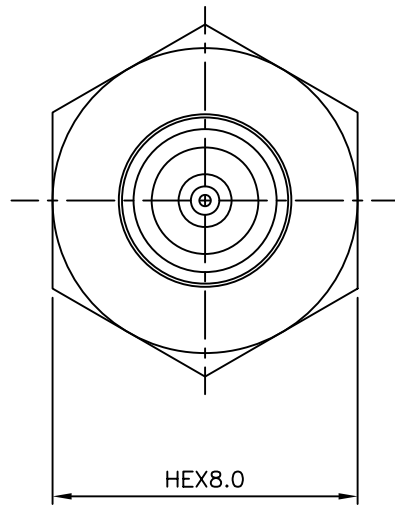
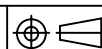


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.M.LEE	I.C.KIM	2015.04.10.



3	INSULATOR	1	TEFLON		DIN02574-N/1
2	CONTACT	1	MBsBD C3604BD-F	Silver Plate	DCT03453-5/1
1	BODY	1	MBsBD C3604BD-F	SUCO Plate	DBD03919-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2015. 04. 10.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017 KJ COMTECH CO.,LTD.		
	Angle ±1°	APPROVED BY I.C.KIM					
MATERIAL -		CHECKED BY			TITLE SMP50 SOLDER END JB (F/F)		
		DRAWN BY S.M.LEE					
FINISH -		SCALE 5/1	UNIT mm		A4	DWG NO. CN03413-7/1	SHEET 1 of 1
						REVISION I R	